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**Continuity of ordering part numbers**

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Rev.	ECN No.	Origin of Change	Description of Change
**	1108		NEW RELEASE
*A	1545		ADD TOLERANCE ON DIM.
*B	49412		CHANGE TITLE
*C	412838		ADD NOTES-- JEDEC REFERENCE MS-026 -MOLD PROTRUSION/END FLASH INFORMATION
*D	2835671		Changed template, & title from 44LD TQFP (10 X 10 X 1.4) PKG OUTLINE to PACKAGE OUTLINE, 44LD TQFP 10X10X1.4 MM A44S.
*E	3146096		ECN SUNSET NO CHANGE
*F	4257091	KTQAD/ XANC	SUNSET REVIEW. CHANGED DRAWING TEMPLATE.
*G	4991833	XANC	Changed terminal tolerance from $\pm 0.25$ to $\pm 0.20$ .



TITLE  
PACKAGE OUTLINE, 44LD TQFP 10X10X1.4 MM A44S

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PACKAGE CODE(S)

A44S

SPEC NO. 51-85064	REV *G
SCALED TO FIT	N/A
SHEET 2 OF 2	